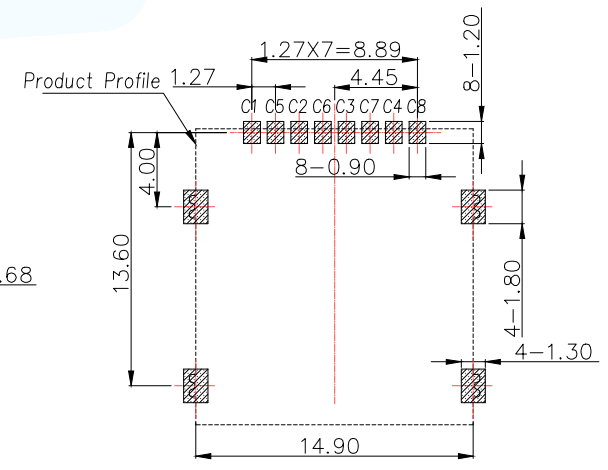
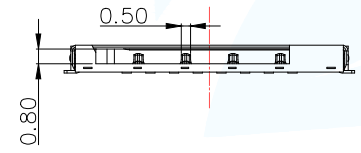
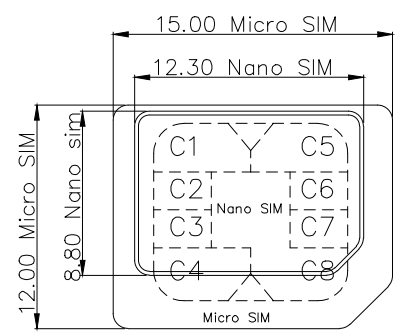


SECTION: A-A



MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A

- NOTES:
- ELECTRICAL CHARACTERISTICS
 - 1-1. CONTACT RESISTANCE: 60 MILLIOHMS MAX
 - 1-2. INSULATION RESISTANCE: 1,000 MEGOHMS MIN.
 - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE.
 - MECHANICAL CHARACTERISTICS
 - 2-1. OPERATION TEMPERATURE RANGE: -25°C~+70°C
 - 2-2. DURABILITY: 5000 CYCLES
 - MATERIAL:
 - 3-1. HOUSING: THERMOPLASTIC,UL 94-V0
 - 3-2. TERMINAL: PHOSPHOR BRONZE,T=0.15
 - 3-3. SHELL: STAINLESS STEEL,T=0.15
 - FINISHED:
 - 4-1. TERMINAL: NI PLATED UNDER,AU PLATED ON CONTACT AREA,G/F PLATED ON SOLDERTAIL



PAD AREA
 KEEP OUT AREA

RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE: MICRO SIM CARD HINGED 8PIN H1.5 翻盖式	
DECIMALS:	ANGLES:	PAR	SMC-220
X.: ±0.5	X.°: ±5°	DWN	Allen
X.X: ±0.25	X.X: ±3°	CHKD	
X.XX: ±0.12		APVD	
CUSTOMER COPY		SCALE: 1:1	UNIT: MM
		SIZE: A4	SHEET: 1F1
			REV: A

